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Dublin Institute of Technology
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EDITOR-IN-CHIEF

M. S. Wald, Dublin Institute of Technology, Bolton Street, Dublin, Ireland
Tel: (International +353 1) 4023635; Fax: (+353 1) 4023999; E-Mail: wald@dit.ie
Website: <http://www.ijee.dit.ie>. Editor's direct phone: (+353 27) 61400.

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AIMS AND SCOPE

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